INTEGRATED CIRCUITS

DATA SHEET

74LVC125A

Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-State)

Product specification Supersedes data of 1997 Aug 01 IC24 Data Handbook







Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-state)

74LVC125A

FEATURES

- 5-volt tolerant inputs/outputs, for interfacing with 5-volt logic
- Supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- CMOS low power consumption
- Direct interface with TTL levels
- High impedance when V_{CC} = 0V

DESCRIPTION

The 74LVC125A is a high performance, low-power, low-voltage Si-gate CMOS device and superior to most advanced CMOS compatible TTL families.

Inputs can be driven from either 3.3V or 5.0V devices. In 3-state operation, outputs can handle 5V.

The 74LVC125A consists of four non-inverting buffers/line drivers with 3-state outputs. The 3-state outputs (nY) are controlled by the output enable input (nOE). A HIGH at nOE causes the outputs to assume a high impedance OFF-state.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5 \text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t _{PHL} /t _{PLH}	Propagation delay nA to nY	$C_L = 50 \text{ pF};$ $V_{CC} = 3.3 \text{ V}$	3.0	ns
C _I	Input capacitance		5.0	pF
C _{PD}	Power dissipation capacitance per buffer	V _{CC} = 3.3 V Notes 1 and 2	25	pF

NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P $_{\!D}$ in $\mu W)$

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; C_L = output load capacity in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V;

 $\sum (C_L \times V_{CC}^2 \times f_0) = \text{sum of the outputs.}$

2. The condition is $V_I = GND$ to V_{CC}

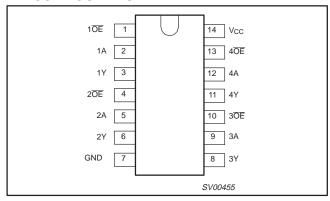
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic SO	-40°C to +125°C	74LVC125A D	74LVC125A D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +125°C	74LVC125A DB	74LVC125A DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to +125°C	74LVC125A PW	7LVC125APW DH	SOT402-1

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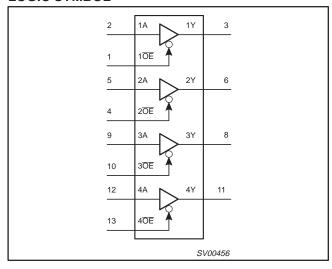
PIN CONFIGURATION



PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 4, 10, 13	1 OE – 4 OE	Data enable inputs (active LOW)
2, 5, 9, 12	1A – 4A	Data inputs
3, 6, 8, 11	1Y – 4Y	Data Outputs
7	GND	Ground (0 V)
14	V _{CC}	Positive supply voltage

LOGIC SYMBOL



FUNCTION TABLE

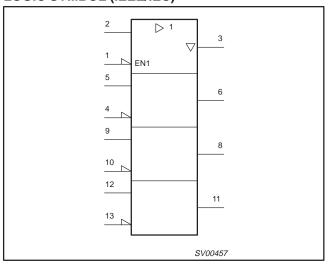
INPU	OUTPUT	
nOE	nA	nY
L	L	L
L	Н	Н
Н	х	Z

NOTES:

H = HIGH voltage level L = LOW voltage level X = don't care

Z = high impedance OFF-state

LOGIC SYMBOL (IEEE/IEC)



Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-state)

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIM	IITS	UNIT
STWIBUL	PARAMETER	CONDITIONS	MIN	MAX	UNIT
\/	DC supply voltage (for max. speed performance)		2.7	3.6	V
V _{CC}	DC supply voltage (for low-voltage applications)		1.2	3.6	V
VI	DC input voltage range		0	5.5	V
Vo	DC output voltage range; output HIGH or LOW state		0	V _{CC}	V
	DC output voltage range; output 3-State		0	5.5	
T _{amb}	Operating ambient temperature range in free-air		-40	+85	°C
t _r , t _f	Input rise and fall times	$V_{CC} = 1.2 \text{ to } 2.7V$ $V_{CC} = 2.7 \text{ to } 3.6V$	0 0	20 10	ns/V

ABSOLUTE MAXIMUM RATINGS¹

In accordance with the Absolute Maximum Rating System (IEC 134) Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +6.5	V
I _{IK}	DC input diode current	V _I < 0	-50	mA
VI	DC input voltage	Note 2	-0.5 to +6.5	V
lok	DC output diode current	$V_{O} > V_{CC}$ or $V_{O} < 0$	±50	mA
V	DC output voltage; output HIGH or LOW state	Note 2	-0.5 to V _{CC} +0.5	V
Vo	DC output voltage; output 3-State	Note 2	-0.5 to 6.5	V
I _{OUT}	DC output source or sink current	$V_O = 0$ to V_{CC}	±50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		±100	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	500 500	mW

NOTES:

^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-state)

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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions voltages are referenced to GND (ground = 0V)

			L	IMITS		
SYMBOL	PARAMETER	TEST CONDITIONS	Temp = -	+85°C	UNIT	
			MIN	TYP ¹	MAX	
V	LUCLI lovel lanut voltage	V _{CC} = 1.2V	V _{CC}			V
V _{IH}	HIGH level Input voltage	V _{CC} = 2.7 to 3.6V	2.0			1
.,	LOW lavel land to the se	V _{CC} = 1.2V			GND	V
V_{IL}	LOW level Input voltage	V _{CC} = 2.7 to 3.6V			0.8	1 °
		$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -12\text{mA}$	V _{CC} -0.5			
	LUCLI lovel outrot veltere	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = -100 \mu\text{A}$	V _{CC} -0.2	V _{CC}		
V _{OH}	HIGH level output voltage	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -18$ mA	V _{CC} -0.6		1 °	
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = -24$ mA	V _{CC} -0.8			1
		$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 12\text{mA}$			0.40	
V_{OL}	LOW level output voltage	$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL}; I_O = 100 \mu A$		GND	0.20	V
		$V_{CC} = 3.0V; V_I = V_{IH} \text{ or } V_{IL;} I_O = 24\text{mA}$			0.55	1
I _I	Input leakage current	V _{CC} = 3.6V; V _I = 5.5V or GND		±0.1	±5	μΑ
I _{OZ}	3-State output OFF-state current ²	$V_{CC} = 3.6V$; $V_I = V_{IH}$ or V_{IL} ; $V_O = 5.5V$ or GND		0.1	±5	μА
I _{off}	Power off leakage supply	$V_{CC} = 0.0V; V_{I} \text{ or } V_{O} = 5.5V$		0.1	±10	μА
I _{CC}	Quiescent supply current	$V_{CC} = 3.6V$; $V_I = V_{CC}$ or GND; $I_O = 0$	1	0.1	10	μА
Δl _{CC}	Additional quiescent supply current per input pin	$V_{CC} = 2.7 \text{V to } 3.6 \text{V}; V_{I} = V_{CC} - 0.6 \text{V}; I_{O} = 0$		5	500	μΑ

AC CHARACTERISTICS

GND = 0 V; t_r = t_f = 2.5 ns; C_L = 50 pF; R_L = 500 Ω

			LIMITS							
SYMBOL	PARAMETER	WAVEFORM	V _{CC}	= 3.3V ±0).3V	V _{CC} =	: 2.7V	V _{CC} = 1.2V	UNIT	
			MIN	TYP ¹	MAX	MIN	MAX	TYP		
t _{PHL} t _{PLH}	Propagation delay nA to nY	Figures 1, 3	1.5	3.0	4.8	1.5	5.5	12.0	ns	
t _{PZH}	3-State output enable time nOE to nY	Figures 2, 3	1.5	3.8	5.7	1.5	6.7	13.0	ns	
t _{PHZ} t _{PLZ}	3-State output disable time nOE to nY	Figures 2, 3	1.5	3.7	5.2	1.5	6.2	8	ns	

All typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.
 For I/O ports the parameter I_{OZ} includes the input leakage current.

^{1.} These typical values are at V_{CC} = 3.3V and T_{amb} = 25°C.

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SW00047

AC WAVEFORMS

 V_M = 1.5 V at $V_{CC} \ge 2.7$ V; V_M = 0.5 • V_{CC} at $V_{CC} < 2.7$ V

 \mbox{V}_{OL} and \mbox{V}_{OH} are the typical output voltage drop that occur with the output load.

 $V_X = V_{OL} + 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V}$

 $V_X = V_{OL} + 0.1 \text{ V at } V_{CC} > 2.7 \text{ V}$

 $V_Y = V_{OH} - 0.3 \text{ V at } V_{CC} \ge 2.7 \text{ V}$

 $V_Y = V_{OH} - 0.1 \text{ V at } V_{CC} < 2.7 \text{ V}$

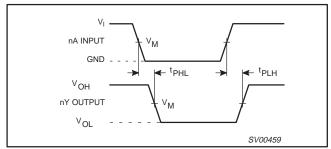


Figure 1. Input (nA) to output (nY) propagation delays.

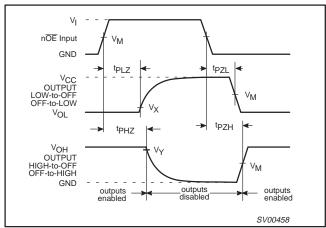


Figure 2. 3-state enable and disable times.

TEST CIRCUIT

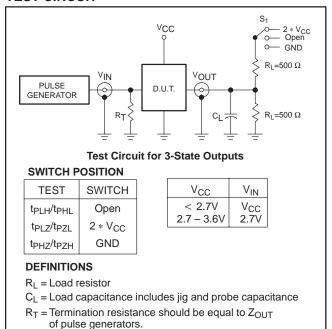


Figure 3. Load circuitry for switching times.

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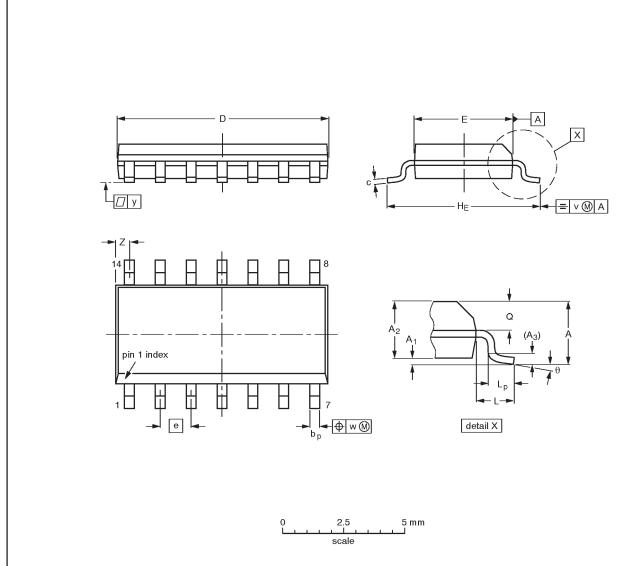
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Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-State)

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.0098 0.0039		0.01		0.0098 0.0075		0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

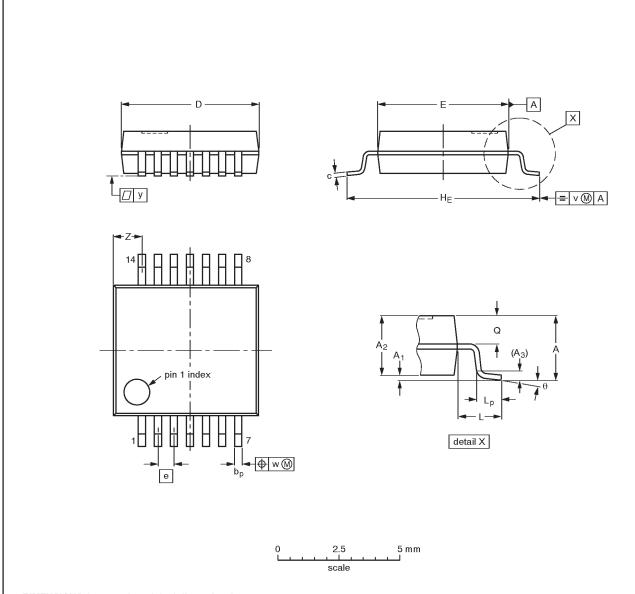
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION		
SOT108-1	076E06\$	MS-012AB				91-08-13 95-01-23	

Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-State)

74LVC125A

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	c	D ⁽¹⁾	E ⁽¹⁾	e	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.4 0.9	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

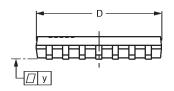
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT337-1		MO-150AB				-95-02-04 96-01-18	

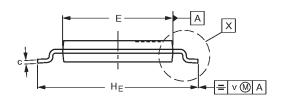
Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-State)

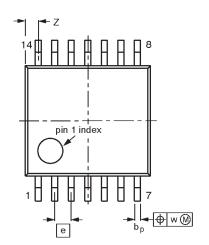
74LVC125A

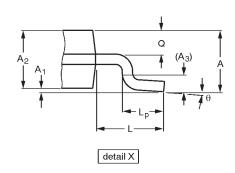
TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1











DIMENSIONS (mm are the original dimensions)

UNIT	A max.	Α1	A ₂	A ₃	bр	c	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.72 0.38	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	ĺ
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	١
SOT402-1		MO-153			94-07-12 95-04-04	

Quad buffer/line driver with 5-volt tolerant inputs/outputs (3-State)

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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